Microcavity Surface-Emitting Laser with Record Low Threshold Current of 190 µA

T. Kawakami, T. Numai, T. Yoshikawa, M. Sugimoto, Y. Sugimoto, H. Yokoyama, K. Kasahara, and K. Asakawa

Opto-Electronics Research Laboratories, NEC Corporation 34 Miyukigaoka, Tsukuba, Ibaraki 305, JAPAN Phone: +81-298-50-1175, Fax.: +81-298-56-6140

Since the advent of semiconductor lasers, reduction of a threshold current ¹) has been an important research theme. For this purpose, a microcavity surface-emitting laser ²), ³), ⁴) is one of the most promising devices. Here, we demonstrate a record low threshold current of 190 μ A in a microcavity surface emitting laser with a 5 μ m diameter airpost.

Figure 1 shows the structure of a microcavity surface-emitting laser. This device has a *pin* structure sandwiched between p- and n-distributed Bragg reflectors (DBRs). The epilayers grown on an n-GaAs substrate by molecular beam epitaxy (MBE) for the *pin* structure are as follows: an n-Al_{0.25}Ga_{0.75}As layer (0.13 μ m, Si doped at 5 x 10¹⁶ cm⁻³), an undoped 10 nm-thick In_{0.2}Ga_{0.8}As strained single quantum well active layer sandwiched between undoped GaAs and Al_{0.25}Ga_{0.75}As barriers, and a p-Al_{0.25}Ga_{0.75}As layer (0.13 μ m, Be doped at 5 x 10¹⁶ cm⁻³). The undoped layers are p type and the background carrier concentrations are 1 x 10¹⁵ cm⁻³. The DBRs consist of alternate layers of AlAs and GaAs which make quarter-wave stack. There are 28.5 periods in the bottom reflector (Si doped at 2 x 10¹⁸ cm⁻³) and 24 periods in the top reflector (Be doped at 2 x 10¹⁹ cm⁻³). A p-GaAs cap layer (0.16 λ , Be doped at 2 x 10²⁰ cm⁻³), which also acts as a phase-matching layer, is grown on the surface of the top reflector. Reactive ion beam etching (RIBE) with Cl₂⁵ was applied to form a 5 μ m diameter airpost. The scanning electron micrograph of the airpost is shown in Figure 2.

Figure 3 shows the current vs. light-output (I-L) characteristic in pulsed operation at room temperature with no heat sink. The pulse width is $0.5 \,\mu$ s, and the pulse repetition rate is 100 kHz. A record low threshold current of 190 μ A was achieved, and the threshold voltage was only 2.4 V. It is considered that this low threshold current indicates that quality of the MBE grown wafer is high⁶, the dry-etched surface is smooth enough to guide light, and the non-radiative recombination at the sidewall is low enough. Light-output above threshold was linearly polarized, and the intensity ratio between the two orthogonal lights was about 40.

In conclusion, we have achieved a record low threshold current of 190 μ A in a microcavity surface-emitting laser with a 5 μ m diameter airpost, in pulsed operation at room temperature.

References:

1) T. Numai, H. Kosaka, I. Ogura, K. Kurihara, M. Sugimoto, and K. Kasahara: IEEE J. Quantum Electron. 29 (1993) 403 .

2) H.Yokoyama, T. Kawakami, and Y. Nambu: to be published in *Confined Electrons and Photons: New Physics and Devices*, ed. C.Weisbuch (Plenum, Boston, 1993)

3) T. Baba T. Hamano, F. Koyama, and K. Iga: IEEE J. Quantum. 27 (1991) 1347. ibid.28 (1992) 1310.

4) F. M. Matinaga, A. Karlsson, S. Machida, and Y. Yamamoto: Appl. Phys. Lett. 62 (1993) 443.

5) K. Asakawa and S. Sugata: J. Vac. Sci. Tech. B 3 (1985) 385.

6) M. Sugimoto, I. Ogura, H. Saito, A. Yasuda, K. Kurihara, H. Kosaka, T. Numai, and K. Kasahara: J. Crystal Growth 127 (1993) 1.





Fig. 1 Device structure of a microcavity surface-emitting laser. Airpost diameter is 5 µm.

Fig. 2 Scanning electron micrograph of the airpost made by RIBE.



Fig. 3 Current vs. light-output characteristic for pulsed operation at room temperature. The pulse width is 0.5 μ s and the pulse repetition rate is 100 kHz.